

Standard Marking on Optocouplers

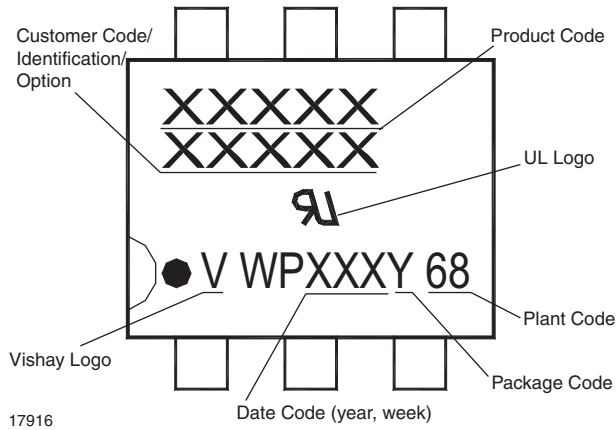


Figure 1. 6-pin

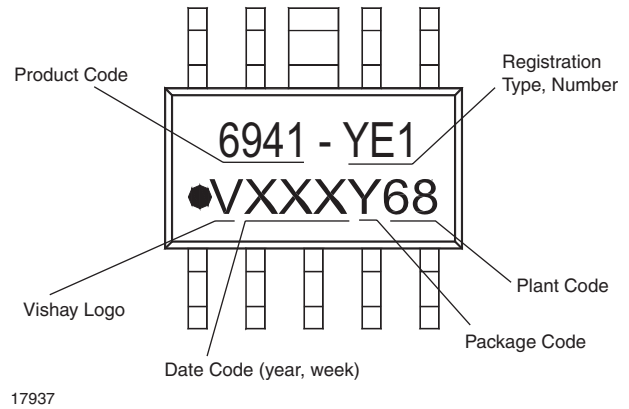


Figure 4. Minicoupler

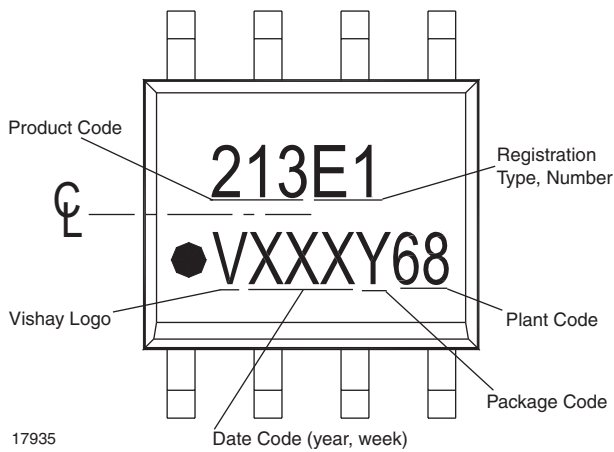


Figure 2. Single and Dual SO-8

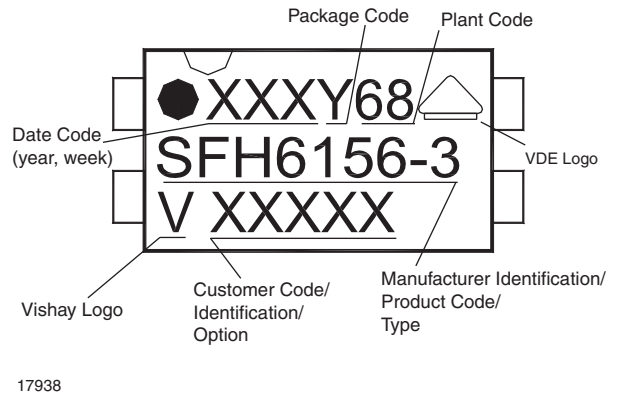


Figure 5. DIP-4 Products

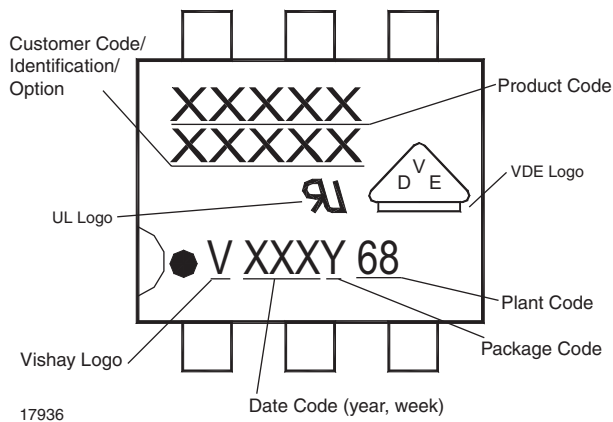


Figure 3. DIP-6 Products

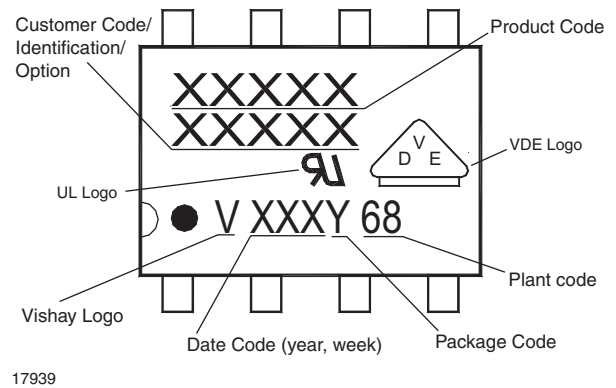


Figure 6. DIP-8 Products

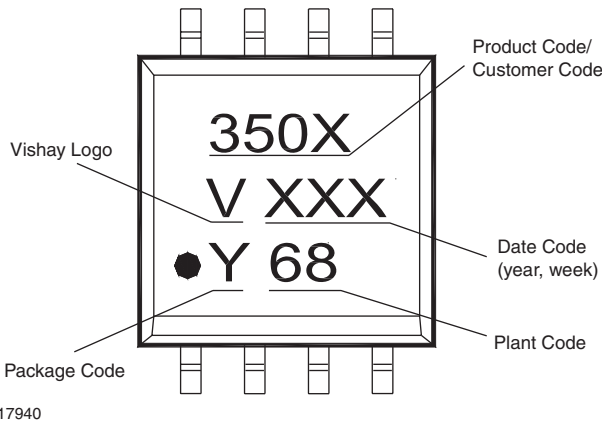


Figure 7. PCMCIA Products

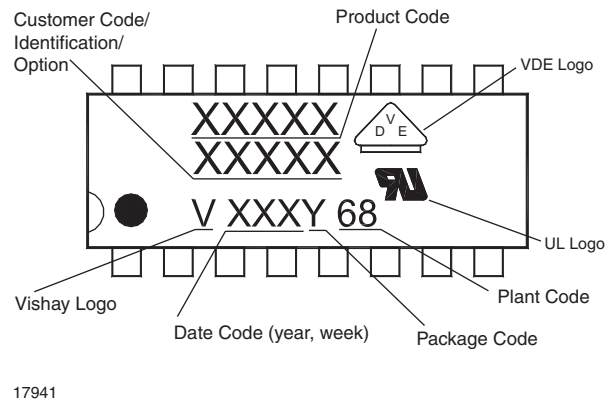


Figure 9. DIP-16 Products

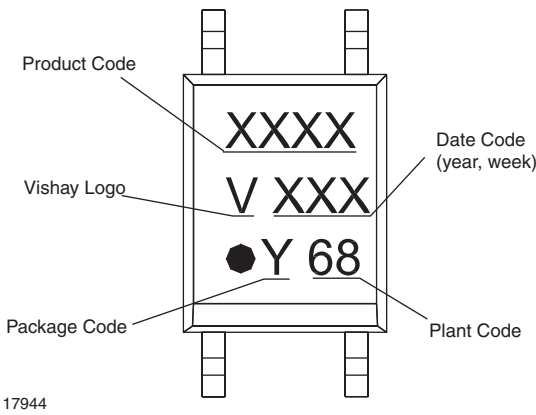


Figure 8. Pin Miniflat/ 4 Pin Flatpack

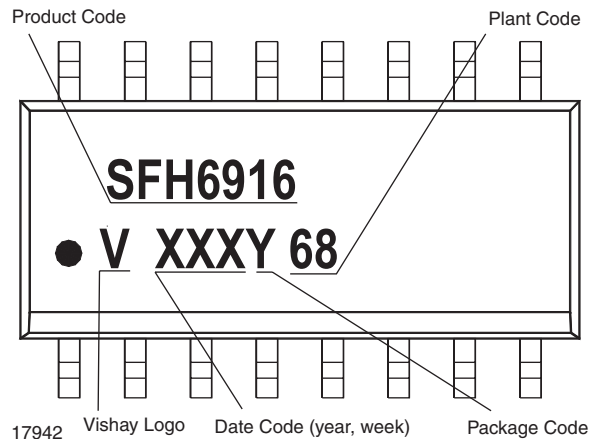


Figure 10. 16 Pin Miniflat

Markings

The following table defines the option information that is marked on the product.

Option type	Marking	Definition
X001, X001T	X001	Partial discharge test per DIN EN 60747-5-2 (VDE0884)
X006	No mark	10.16 mm (400 mil) through hole lead spread
X007, X007T	X007	SMD lead form bend, 0.9 mm maximum standoff height
X008, X008T	X008	SMD lead form bend, 9.3 mm lead spread
X009, X009T	No Mark	SMD lead form bend, 0.25 mm maximum standoff height
X016	X001	Partial discharge test and 400 mil through hole lead spread
X017, X017T	X017	Partial discharge test and SMD lead form bend, 0.9 mm standoff
X018, X018T	X018	Partial discharge test and SMD lead form bend, 9.3 mm lead spread
X019, X019T	X001	Partial discharge test and SMD lead form bend, 0.25 mm standoff

Options are added to optocouplers in DIP package. For SOIC-8 packages, only option 1 can be added. Please contact your local Vishay sales office for availability of option combinations.